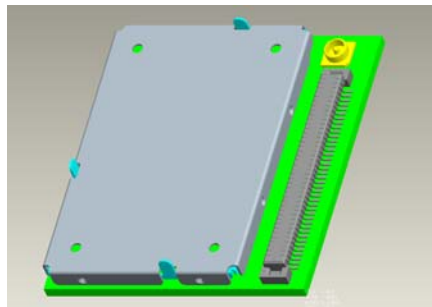


iSR3500 Series GSM / GPRS Module

Pre-Release Rev 0.3

2008. 03. 28



Sirius Mobility

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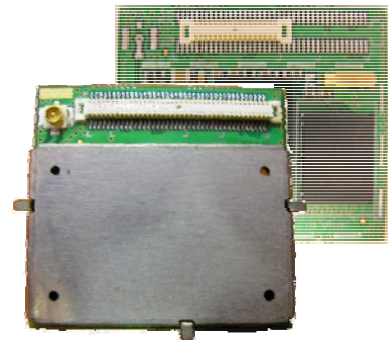
email: sales@i-sirius.com.sg

1 Introduction

1.1 General Description

iSR3500 series is a product line of single-module platform optimized for ultra low cost GSM/GPRS modem and generic mobile applications. It integrates all the functions necessary for a dual-band GSM/GPRS wireless communication, including baseband, mixed signal, power amplifier, power management, RF transceiver, front-end switch and memory in a single monolithic module with board-to-board connector

The highly integrated module is ideal for application requiring GSM, and is capable of working on 2-layer motherboard with no further RF calibration required.



26.8 x 28.0 x 2.8

1.2 Key Features

GSM or GPRS Dual Band Protocol Stack	900/1800 MHz or 850/1900 MHz, GSM Rel.97. STK Rel.99 GPRS Rel4.0 Class 10
Speech Codec	EFR / FR / HR / AMR
Security	Hardware support for IMEI, SIM-Lock, Flash Software Protection and Secure Boot
Messaging	SMS concatenated EMS, Smart messaging (GPRS)
Browsing	CSD, Jataayu WAP 1.2 (GPRS)
Text Input	T9 and/or Z8 library word recognition
Output Power	Class 4 (2W) at 850/900 MHz Class 1 (1W) at 1800/1900 MHz
Supply Voltage	3.4V ~ 4.2V, Nominal : 3.7V
Power consumption	Power off < 200uA Idle mode < 4mA
GSM Sensitivity	-110 dBm (typ) at 850/900 MHz -109 dBm (typ) at 1800/1900 MHz
LCD feature	up to 96x64 FSTN (iSR3516) up to 128x128 FSTN (iSR3532) up to 160x128 65K CSTN (iSR353204)
Clock	26MHz reference clock 26MHz for MCU sub-system 78MHz for DSP
Interface	8 bit parallel interface SSC / SPI interface I2C Bus UART
Communication	Extendable AT Commands (GPRS)
ADC	1 open ADC 1 ADC (TBAT) is reserved for battery temperature monitoring
Headset hook detection	
Audio	Analog audio for ring tone (balanced and unbalanced) Analog audio for receiver (balanced and unbalanced) Balanced analog microphone interface Unbalanced external microphone interface for headset
LED backlight	White LED buck-booster embedded, requires only external FET and diode for switching
Debug	JTAG support
Charging	Pulse charging support for both Ni-MH and Li-ion battery
Vibrator	Support Vibrator control output
Keypad Support	6 x 4 key inputs

1.3 Ordering Information

iSR35<nnnn>-<c><p>

 = GSM band option, E or U

<nnnn> = memory option, 16, 32, 3204, 3208 or 6416

please note that other RAM configuration will be incorporated in the future

<c> = b2b connector size option, C1, C2 or C3

<p> = packaging option, R or T

1.4 Product part number

iSR35E16	GSM 900/1800MHz band,	16Mbit Flash
iSR35E32	GSM 900/1800MHz band,	32Mbit Flash
iSR35E3204	GSM 900/1800MHz band,	32Mbit Flash + 4Mbit static RAM
iSR35E3208	GPRS 900/1800MHz band,	32Mbit Flash + 8Mbit static RAM
iSR35E6416	GPRS 900/1800MHz band,	64Mbit Flash + 16Mbit static RAM
iSR35U16	GSM 850/1900MHz band,	16Mbit Flash
iSR35U32	GSM 850/1900MHz band,	32Mbit Flash
iSR35U3204	GSM 850/1900MHz band,	32Mbit Flash + 4Mbit static RAM
iSR35U3208	GPRS 850/1900MHz band,	32Mbit Flash + 8Mbit static RAM
iSR35U6416	GPRS 850/1900MHz band,	64Mbit Flash + 16Mbit static RAM

Connector Option

C1 = 34 pins

C2 = 60 pins

C3 = 80 pins

2 Electrical Specification

2.1 Absolute Maximum Rating

The maximum rating may not be exceeded under any circumstances as permanent damage to the module will result

Parameter	Pin	Limit Values		Unit
		Minimum	Maximum	
Battery Supply	Vbat1, Vbat2, Vbat3	-0.15	- +5.5	V
Output Load VSWR	ANT	10:1		
Storage Temperature		-55	+150	°C
ESD			1000	V
Digital I/O sink current			20	mA
Digital I/O Level			3.6	V

2.2 Electrical Characteristics

At operating Temperature: -20°C ~ 60°C

Parameter	Pin	Min.	Typ.	Max	Unit
Battery Power supply	Vbat1,Vbat2,Vbat3	3.4	3.8	4.2	V
Charger Detection Voltage	CDT	0		2.5	V

Battery charging protection voltage	Vbat1,Vbat2,Vbat3	4.47 / 5.5			V
Supported Battery Voltage for charging	Ni-MH Li-ion	3.1 3.1		5.1 4.2	V
VSIM		-3%	1.8/2.85	+3%	
VIO Voltage	VIO,VDDP_IO	-3%	2.85	+3%	V
VIO Output current	I _{VIO}			30	mA
VDDP_MEM Domain	VDDP_MEM	-3%	2.85	+3%	V
VRTC Voltage	VRTC,VDDP_RTC	1.86	2	2.14	V
VRTC Output Current				4	mA
VSIM Voltage	VSIM	-3%	1.8/2.85	+3%	V
VSIM Output Current	I _{VSIM}			30	mA
VMIC	VMIC		2.2		V
Digital I/O range	GPIO _i	-0.3	2.85	3	V
Digital I/O Low level	V _{I/O} L	-0.2		0.3	V
Digital I/O High level	V _{I/O} H	2.55	2.85V	3	V
Audio					
Receiver Max differential Output	EPP1,EPN1	3.3	3.7	4.1	V _{pp}
Headset Max single-ended output	EPPA	1.65	1.85	2.05	V _{pp}
Receiver Output Load resistance	EPP1,EPN1		16		Ω
Headset Output Load resistance	EPPA		32		Ω
Ringer Output Load resistance	LOUD1,LOUD2		8		Ω
ADC Input Voltage (External input voltage case)	TBAT,ADC1			2.4	V

2.3 GSM 850 Electrical characteristics

Nominal Conditions (unless otherwise specified): V_{batt}=3.8V T_a=25°C

Parameter	Conditions	Min.	Typ.	Max.	Unit
Frequency		824		849	MHz
Maximum Output Power	Nominal conditions	32.5	33		dBm
2 nd Harmonic 3 rd Harmonic All other harmonics up to 13 GHz	P _{out} ≤33dBm		-40		dBm
Sensitivity		-108			dBm
Off current			150		μA
Idle current	Average at DRX=5		2.5		mA
Traffic mode current			250		mA

2.4 GSM 900 Electrical characteristics

Nominal Conditions (unless otherwise specified): V_{batt}=3.8V T_a=25°C

Parameter	Conditions	Min.	Typ.	Max.	Unit
Frequency		880		915	MHz
Maximum Output Power	Nominal conditions	32.5	33		dBm
2 nd Harmonic 3 rd Harmonic All other harmonics up to 13 GHz	P _{out} ≤33dBm		-40		dBm
Sensitivity		-106			dBm
Off current			150		μA
Idle current	Average at DRX=5		2.5		mA
Traffic mode current			250		mA

2.5 DCS Electrical characteristics

Nominal Conditions (unless otherwise specified): $V_{batt}=3.8V$ $T_a=25^{\circ}C$

Parameter	Conditions	Min.	Typ.	Max.	Unit
Frequency		1710		1880	MHz
Maximum Output Power	Nominal conditions		30		dBm
2nd Harmonic 3rd Harmonic All other harmonics up to 13 GHz	$P_{out} \leq 33dBm$		-40		dBm
Sensitivity		-106			dBm
Off current			150		μA
Idle current	Average at DRX=5		2.5		mA
Traffic mode current			250		mA

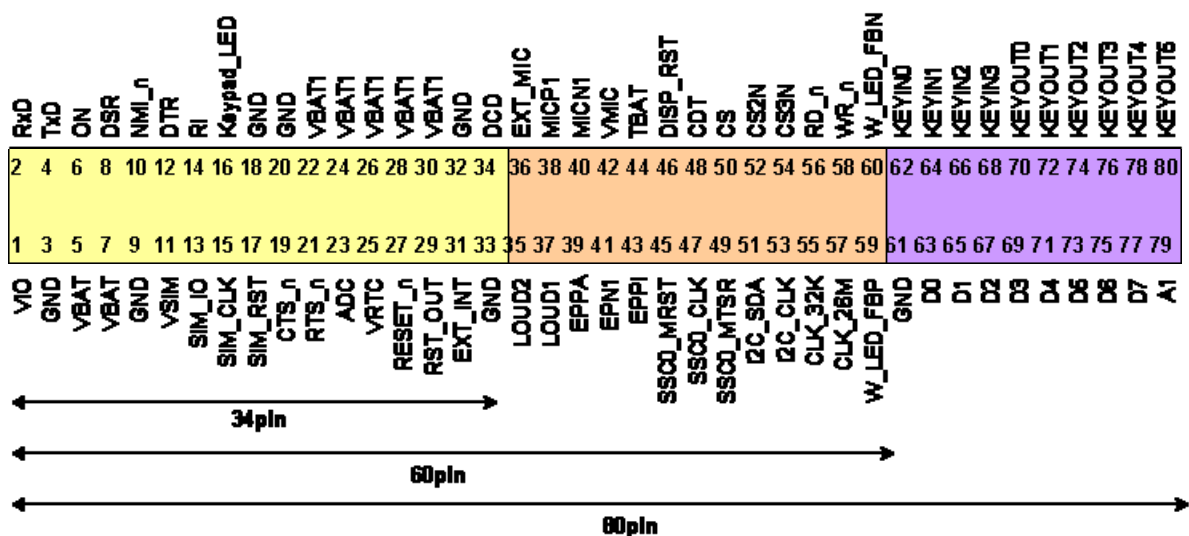
2.6 PCS Electrical characteristics

Nominal Conditions (unless otherwise specified): $V_{batt}=3.8V$ $T_a=25^{\circ}C$

Parameter	Conditions	Min.	Typ.	Max.	Unit
Frequency		1850		1990	MHz
Maximum Output Power	Nominal conditions		30		dBm
2nd Harmonic 3rd Harmonic All other harmonics up to 13 GHz	$P_{out} \leq 33dBm$		-40		dBm
Sensitivity		-108			dBm
Off current			150		μA
Idle current	Average at DRX=5		2.5		mA
Traffic mode current			250		mA

3 Pin Diagram

Pin numbering from top view of module



4 iSR35xx Module Pin description

Pin#	Name	Description	Dir	Category	GPIO	Supply Domain
1	VIO	VDDP_IO		Power supply		
3	GND	GND				
5	VBAT	Vbatt for PMU		Power supply		VBAT
7	VBAT	Vbatt for PMU		Power supply		VBAT
9	GND	GND				
11	VSIM	VDD SIM		SIM Card		VDDP_SIM
13	SIM_IO	SIM Data	I/O	SIM Card		VDDP_SIM
15	SIM_CLK	SIM Clock	O	SIM Card		VDDP_SIM
17	SIM_RST	SIM Reset	O	SIM Card		VDDP_SIM
19	CTS_n	Clear To Send	I	UART	GPIO 13	
21	RTS_n	Headset Detection (mobile), or Request To Send (modem)	O	UART	GPIO 12	VDDP_IO
23	ADC	ADC				
25	VRTC	VRTC		Power supply		
27	RESET_n	RESET/	I/O	Peripheral interface		VDDP_RTC
29	RST_OUT	Reset Out	O		GPIO 32	VDDP_IO
31	EXT_INT	External Interrupt	I/O	GPIO	GPIO 33	VDDP_IO
33	GND	GND				
35	LOUD2	Loud Speaker N	O	Speaker		LBUF
37	LOUD1	Loud Speaker P	O	Speaker		LBUF
39	EPPA	External earpiece	O	Speaker		VDDA_VANA
41	EPN1	Earpiece N	O	Speaker		
43	EPP1	Earpiece P	O	Speaker		
45	SSC0_MRST	SSC0 MRST	I/O	SSC	GPIO 15	VDDP_IO
47	SSC0_CLK	SSC0 CLK	I/O	SSC	GPIO 14	VDDP_IO
49	SSC0_MTSR	SSC0 MTSR	I/O	SSC	GPIO 16	VDDP_IO
51	I2C_SDA	I2C Data	I/O	I2C	GPIO 19	VDDP_IO
53	I2C_CLK	I2C Clock	I/O	I2C	GPIO 18	VDDP_IO
55	CLK_32K	Clock 32K Output	O	GPIO	GPIO 28	VDDP_IO
57	CLK_26M	Clock 26M Output	O	GPIO	GPIO 30	VDDP_IO
59	W_LED_FBP	White LED feedback P	I	white LED		
61	GND	GND				
63	D0	Data 0	I/O	Data		VDDP_MEM
65	D1	Data 1	I/O	Data		VDDP_MEM
67	D2	Data 2	I/O	Data		VDDP_MEM
69	D3	Data 3	I/O	Data		VDDP_MEM
71	D4	Data 4	I/O	Data		VDDP_MEM
73	D5	Data 5	I/O	Data		VDDP_MEM
75	D6	Data 6	I/O	Data		VDDP_MEM
77	D7	Data 7	I/O	Data		VDDP_MEM
79	A1	Address 1	O	Peripheral interface		VDDP_MEM

Pin#	Name	Description	Dir	Category	GPIO	Supply Domain
2	RXD	RX Data	I/O	UART	GPIO 10	VDDP_IO
4	TXD	TX Data	O	UART	GPIO 11	VDDP_IO
6	ON	Switch On	I			VDDP_RTC
8	DSR	Data Set Ready	O	UART	GPIO 20	VDDP_IO
10	NMI_n	Non-Maskable Interrupt	I	Interrupt	GPIO 38	VDDP_IO
12	DTR	Data Terminal Ready	I	UART	GPIO 37	VDDP_IO
14	VIB_CTRL / RI	Vibrator control (mobile) Ring Indicator (modem)	I/O	GPIO	GPIO 36	VDDP_IO
16	KEYPAD_LED	Keypad LED control (mobile) HS_DET (modem)	O	GPIO	GPIO 35	VDDP_IO
18	GND	GND				
20	GND	GND				
22	VBAT1	Vbatt for PA				
24	VBAT1	Vbatt for PA				
26	VBAT1	Vbatt for PA				
28	VBAT1	Vbatt for PA				
30	VBAT1	Vbatt for PA				
32	GND	GND				
34	DCD / W_LED_DRV	White LED DRV (mobile) Data Carrier Detect (modem)	O	GPIO White LED	GPIO 34	VDDP_IO
36	EXT_MIC	External Mic	I	MIC		
38	MICP1	MIC P	I	MIC		VDDA_VBT
40	MICN1	MIC N	I	MIC		VDDA_VBT
42	VMIC	MIC Bias		MIC Power supply		VDDA_VBT
44	TBAT	Battery Temperature				
46	DISP_REST	Display Reset	O	Display	GPIO 17	VDDP_IO
48	CDT	Charger Detect		Charger		
50	CS	Charger Switch		Charger		
52	CS2_n	Chip select 2 (CS2/)	O	Peripheral interface	GPIO 24	VDDP_MEM
54	CS3_n	Chip select 3 (CS3/)	O	Peripheral interface	GPIO 39	VDDP_MEM
56	RD_n	READ/	O	Peripheral interface		
58	WR_n	Write/		Peripheral interface		
60	W_LED_FBN	White LED feedback N	I	White LED		
62	KEYIN0	Keypad Input 0	I	Keypad	GPIO 6	VDDP_IO
64	KEYIN1	Keypad Input 1	I	Keypad	GPIO 7	VDDP_IO
66	KEYIN2	Keypad Input 2	I	Keypad	GPIO 8	VDDP_IO
68	KEYIN3	Keypad Input 3	I	Keypad	GPIO 9	VDDP_IO
70	KEYOUT0	Keypad Out 0	O	Keypad	GPIO 0	VDDP_IO
72	KEYOUT1	Keypad Out 1	O	Keypad	GPIO 1	VDDP_IO
74	KEYOUT2	Keypad Out 2	O	Keypad	GPIO 2	VDDP_IO
76	KEYOUT3	Keypad Out 3	O	Keypad	GPIO 3	VDDP_IO
78	KEYOUT4	Keypad Out 4	O	Keypad	GPIO 4	VDDP_IO
80	KEYOUT5	Keypad Out 5	I/O	Keypad	GPIO 5	VDDP_IO

5 iSR35xx Module GPIO Pins and Function

Pin#	Name	Description	GPIO	Supply Domain	Reset Value	GPIO guide
19	CTS_n	Clear to Send	GPIO13	VDDP_IO	T/PU	GPIO or CTR function
21	RTS_n	Request to Send	GPIO12	VDDP_IO	T	GPIO or RTS function
29	RST_OUT	Reset Out	GPIO32	VDDP_IO	T/PD	Can be used for GPIO
31	EXT_INT	Ext. Interrupt	GPIO33	VDDP_IO	T/PD	Can be used for GPIO
45	SSC0_MRST	SSC0_MRST	GPIO15	VDDP_IO	T	GPIO or SSC0 / SPI function
47	SSC0_CLK	SSC0_CLK	GPIO14	VDDP_IO	T	GPIO or SSC0 / SPI function
49	SSC0_MTSR	SSC0_MTSR	GPIO16	VDDP_IO	T	GPIO or SSC0 / SPI function
51	I2C_SDA	I2C Data	GPIO19	VDDP_IO	T/OD	GPIO or I2C function
53	I2C_CLK	I2C Clock	GPIO18	VDDP_IO	T/OD	GPIO or I2C function
55	CLK_32K	Clock 32K	GPIO28	VDDP_IO	T/PU	GPIO or 32Khz clock output
57	CLK_26M	Clock output	GPIO30	VDDP_IO	T/PD	GPIO or 26Mhz clock output
2	RXD	RX Data	GPIO10	VDDP_IO	T	Reserved for UART
4	TXD	TX Data	GPIO11	VDDP_IO	T	Reserved for UART
8	DSR	Data Set Ready	GPIO20	VDDP_IO	T/PD	GPIO or DSR function
10	NMI_n	Non-maskable Int.	GPIO38	VDDP_IO	T/PU	Reserved for NMI function
12	DTR	Data Terminal Ready	GPIO37	VDDP_IO	T/PD	GPIO or DTR function
14	RI / VIB_CTRL	Vibrator control	GPIO36	VDDP_IO	T/PD	GPIO or Ring Indicator
16	KEYPAD_LED	Keypad LED	GPIO35	VDDP_IO	T/PD	GPIO or Keypad LED
34	DCD / W_LED_DRV	Data Carrier Det. White LED DRV	GPIO34	VDDP_IO	T/PD	GPIO or Data Carrier Detect
46	DISP_REST	Display Reset	GPIO17	VDDP_IO	T	Reserved for LCD Reset
52	CS2n	Chip select2	GPIO24	VDDP_MEM	T/PU	GPIO or Chip Select
54	CS3n	Chip select3	GPIO39	VDDP_MEM	T/PU	GPIO or Chip Select
62	KEYIN0	Keypad Input	GPIO 6	VDDP_IO	T	GPIO or Keypad
64	KEYIN1	Keypad Input	GPIO 7	VDDP_IO	T	GPIO or Keypad
66	KEYIN2	Keypad Input	GPIO 8	VDDP_IO	T	GPIO or Keypad
68	KEYIN3	Keypad In	GPIO 9	VDDP_IO	T	GPIO or Keypad
70	KEYOUT0	Keypad Out	GPIO 0	VDDP_IO	T	GPIO or Keypad
72	KEYOUT1	Keypad Out	GPIO 1	VDDP_IO	T	GPIO or Keypad
74	KEYOUT2	Keypad Out	GPIO 2	VDDP_IO	T	GPIO or Keypad
76	KEYOUT3	Keypad Out	GPIO 3	VDDP_IO	T	GPIO or Keypad
78	KEYOUT4	Keypad Out	GPIO 4	VDDP_IO	T	GPIO or Keypad
80	KEYOUT5	Keypad Out	GPIO 5	VDDP_IO	T	GPIO or Keypad

6 iSR35xx Module Test Points on the Bottom

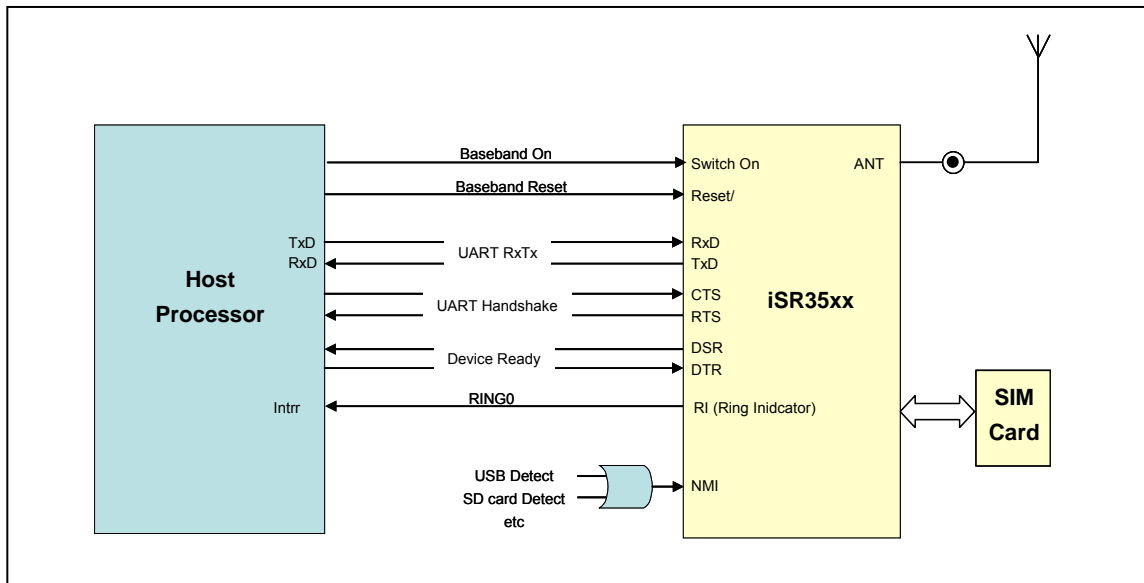
The following test points are available at the bottom centre (refer to 9.2) for JTAG debug (labels are marked on PCB):

VIO TDI TDO TCK TRST_n TMS

For factory test purpose, the following signals are made available at the back of the module (refer to 9.2):

RTS_n CTS_n TXD RXD VRTC ON VBAT VBAT1 GND

7 Application as GSM modem with host processor



Refer to *Design Guide for Industrial Applications* for more detailed reference design.

8 Packaging Information

8.1 Tray (Option T)

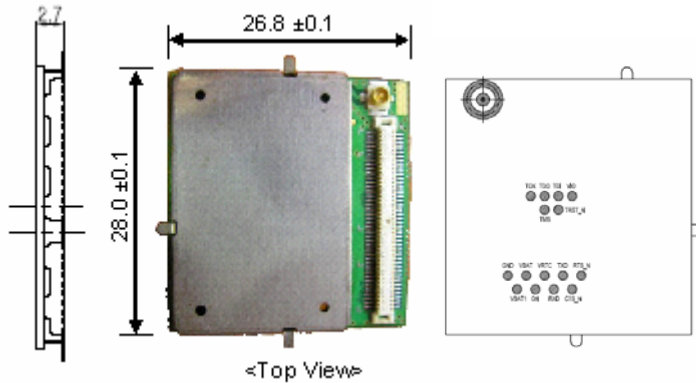
(Dimensions to be finalized)

8.2 Tape and Reel (option R)

(Dimensions to be finalized)

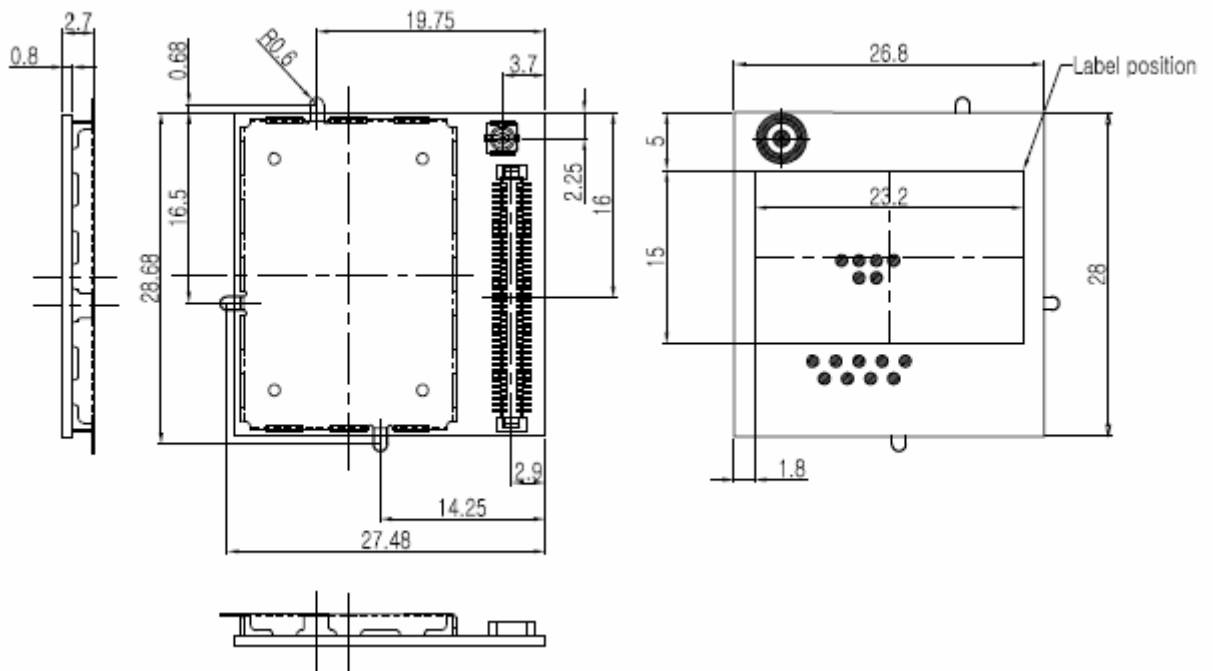
9 Module Dimension (mm)

9.1 Physical size



※ iSR3500 GSM/GPRS Module weight approx 2.4 gram.

9.2 Mechanical Dimension



9.3 Board-to-Board Connector

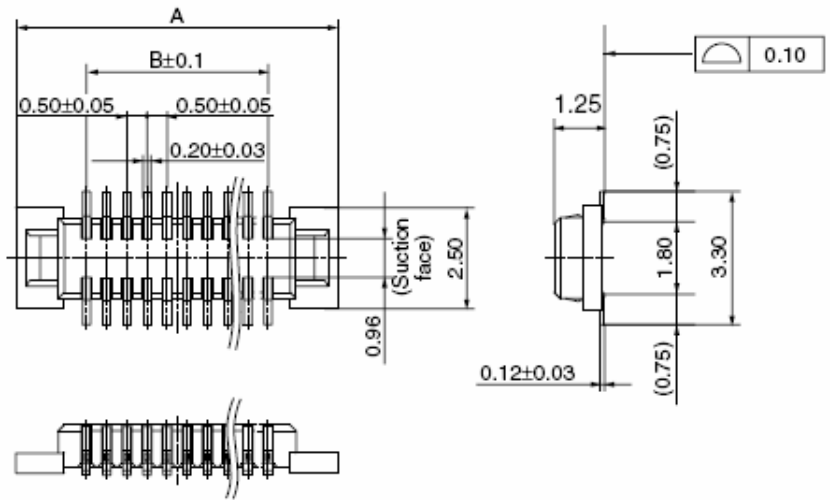
The module uses *Panasonic* narrow pitch (0.5mm) connector **AXK6F34347YG** (34pin header), **AXK6F60347YG** (60pin header) or **AXK6F80347YG** (80pin header). They have the mated height 1.5mm and 2.0mm, without positioning bosses.

Note: The recommended socket connectors on user's mother board are AXK5F34547YG, AXK5F60547YG and AXK5F80547YG respectively.



Dimension table (mm)

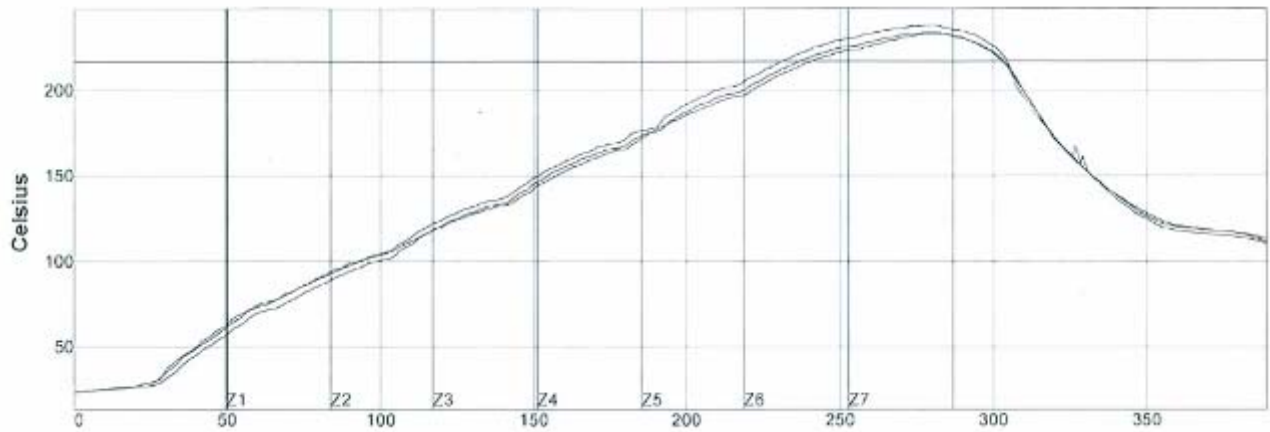
No. of contacts	A	B
34	11.50	8.00
60	18.00	14.50
80	23.00	19.50



10 Reflow temperature profile

Setpoints (Celsius)							
Zone	1	2	3	4	5	6	7
Top	105	125	150	187	225	250	250
Bottom	105	125	150	187	225	250	250

Conveyor Speed (inch/min): 20.0



User's Information --- Additional information

Cautions

Modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC compliance Information

This device complies with part 15 of FCC Rules. Operation is subject to the following two conditions: 1. This device may not cause harmful interference, and 2. This device must accept any interference received. Including interference that may cause undesired operation.

Information to User

This equipment has been tested and found to comply with the limits for a Class B digital device, Pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio Frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.**
- Increase the separation between the equipment and receiver- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.**
- Consult the dealer or an experienced radio/TV technician for help.**

NOTE: Required Minimum distance between antenna and the user is 20cm.

The FCC requires that a label must be placed on the outside of the final product stating:

"Contains FCC ID: VDQDC3500" depending of the module to be integrated.